

FORM 1595 U.S. DEPARTMENT OF COMMERCE
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PATENTS ONLY**

To the Honorable Commissioner of Patents and Trademarks. Please record the attached original documents or copy thereof.

1. Name of conveying party(ies):
Sang Il NAM

Additional name(s) of conveying party(ies) attached? Yes No

2. Name and address of receiving party(ies):
NAME: **POSTECH FOUNDATION**

ADDRESS: **San 31 Hyoja-dong, Nam-gu Pohang-city, Kyung-sangbuk-do, Republic of Korea**

3. Name of Conveyance:
 Assignment Merger
 Security Agreement Change of Name
 Other

Execution/Effective Date: **March 29, 2004**

NAME: **Mu Sang LEE**

ADDRESS: **670-29 Manchon1-dong Suseong-gu Daegu-city, Republic of Korea**

Additional name(s) & addresses(es) attached? Yes No

4. Application number(s) or patent number(s):
If this document is being filed together with a new application, the execution date of the application is: _____

A. Patent Application No.(s)
10/476,418

B. Patent No.(s)

Additional numbers attached? Yes No

5. Name and address of party to whom correspondence concerning document should be mailed:

Name:
Internal Address: **Rothwell, Figg, Ernst & Manbeck Suite 800**
Street Address: **1425 K St., N.W.**
City: **Washington,**
State: **D.C.** Zip: **20005**
Telephone No.: **202/783-6040**
Facsimile No.: **202/783-6031**

Attorney Docket No. : **1751-345**

6. Total number of applications and patents involved: **1**

7. Total fee (37 CFR 3.41): \$ **40.00**
 Enclosed
 Authorized to be charged to deposit account

8. Deposit account number: **02-2135**

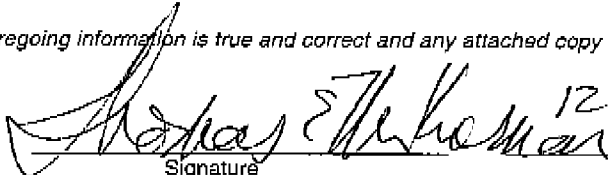
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9. Statement and signature.

To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.

Thomas E. McKiernan
Name of Person Signing


Signature

12 APR 04
Date

Total number of pages including cover sheet, attachments and exhibits: **PATENT** **2**

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ASSIGNMENT

WHEREAS, I, Sang Il NAM, a citizen of Republic of Korea, residing at 1537-12 Pyeongri5-dong, Seo-gu, Daegu-city, Republic of Korea (hereinafter ASSIGNOR) is a co-owner, by virtue of an assignment dated October 24, 2003 of an invention in COLLOID SOLUTION OF METAL NANOPARTICLES, METAL-POLYMER NANOCOMPOSITES AND METHODS FOR PREPARATION THEREOF for which I have executed an application for Letters Patent of the United States, serial number 10/476,418, filed October 30, 2003; and

WHEREAS, POSTECH FOUNDATION, a Korean University, with a place of business at San 31 Hyoja-dong, Nam-gu, Pohang-city, Kyungsangbuk-do, Republic of Korea and Mu Sang LEE, a citizen of Republic of Korea, residing at 670-29 Manchon1-dong, Suseong-gu, Daegu-city, Republic of Korea (hereinafter ASSIGNEES) is desirous of obtaining the entire right, title and interest in, to and under the said invention and the said application;

NOW, THEREFORE, in consideration of the sum of One Dollar (\$1.00) to me in hand paid, and other good and valuable consideration, the receipt of which is hereby acknowledged, I, the said ASSIGNOR have sold, assigned, transferred and set over, and by these presents do hereby sell, assign, transfer and set over, unto the said ASSIGNEES, its successors, legal representatives and assigns, the entire right, title and interest in, to and under the said invention, and the said application and all divisions, renewals and continuations thereof, and all Letters Patent of the United States which may be granted thereon and all reissues and extensions thereof, and all applications for Letters Patent which may hereafter be filed for said invention in any country or countries foreign to the United States, and all Letters Patent which may be granted for said invention in any country or countries foreign to the United States and all extensions, renewals and reissues thereof and all rights of priority in any such country or countries based upon the filing of the said application for Letters Patent of the United States which are created by any law, treaty or international convention; and I hereby authorize and request the Commissioner of Patents of the United States, and any Official of any country or countries foreign to the United States, whose duty it is to issue patents on applications as aforesaid, to issue all Letters Patent for said invention to the said ASSIGNEES, its successors, legal representatives and assigns, in accordance with the terms of this instrument.

AND I HEREBY covenant that I have full right to convey the entire interest herein assigned, and that I have not executed, and will not execute, any agreement in conflict herewith.

AND I HEREBY further covenant and agree that I will communicate to said ASSIGNEES, its successors, legal representatives and assigns, any facts known to me respecting said invention, and testify in any legal proceeding, sign all lawful papers, execute all divisional, continuing and reissue applications, make all rightful oaths and generally do everything possible to aid the said ASSIGNEES, its successors, legal representatives and assigns, to obtain and enforce proper patent protection for said invention in all countries.

IN TESTIMONY WHEREOF, I hereunto set my hand and seal this 29th day of March, 2004.

Sang Il Nam

L.S.

PATENT